

**Vorläufige Daten**  
**preliminary data****IGBT-Wechselrichter / IGBT-inverter****Höchstzulässige Werte / maximum rated values**

|                                                                          |                                                                 |                             |              |        |
|--------------------------------------------------------------------------|-----------------------------------------------------------------|-----------------------------|--------------|--------|
| Kollektor-Emitter-Sperrspannung<br>collector-emitter voltage             | $T_{vj} = 25^{\circ}\text{C}$<br>$T_{vj} = -25^{\circ}\text{C}$ | $V_{CES}$                   | 3300<br>3300 | V      |
| Kollektor-Dauergleichstrom<br>DC-collector current                       | $T_C = 80^{\circ}\text{C}$<br>$T_C = 25^{\circ}\text{C}$        | $I_{C\text{ nom}}$<br>$I_C$ | 200<br>330   | A<br>A |
| Periodischer Kollektor Spitzenstrom<br>repetitive peak collector current | $t_P = 1\text{ ms}$ , $T_C = 80^{\circ}\text{C}$                | $I_{CRM}$                   | 400          | A      |
| Gesamt-Verlustleistung<br>total power dissipation                        | $T_C = 25^{\circ}\text{C}$                                      | $P_{tot}$                   | 2,20         | kW     |
| Gate-Emitter-Spitzenspannung<br>gate-emitter peak voltage                |                                                                 | $V_{GES}$                   | +/-20        | V      |

**Charakteristische Werte / characteristic values**

|                                                                              |                                                                                                                                                                                                                                                                                                                   |                     | min. | typ.         | max.         |                                |
|------------------------------------------------------------------------------|-------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------|---------------------|------|--------------|--------------|--------------------------------|
| Kollektor-Emitter Sättigungsspannung<br>collector-emitter saturation voltage | $I_C = 200\text{ A}$ , $V_{GE} = 15\text{ V}$ , $T_{vj} = 25^{\circ}\text{C}$<br>$I_C = 200\text{ A}$ , $V_{GE} = 15\text{ V}$ , $T_{vj} = 125^{\circ}\text{C}$                                                                                                                                                   | $V_{CE\text{ sat}}$ |      | 3,40<br>4,30 | 4,25<br>5,00 | V<br>V                         |
| Gate-Schwellenspannung<br>gate threshold voltage                             | $I_C = 20,0\text{ mA}$ , $V_{CE} = V_{GE}$ , $T_{vj} = 25^{\circ}\text{C}$                                                                                                                                                                                                                                        | $V_{GEth}$          | 4,2  | 5,1          | 6,0          | V                              |
| Gateladung<br>gate charge                                                    | $V_{GE} = -15\text{ V} \dots +15\text{ V}$ , $V_{CE} = 1800\text{ V}$                                                                                                                                                                                                                                             | $Q_G$               |      | 4,00         |              | $\mu\text{C}$                  |
| Interner Gatewiderstand<br>internal gate resistor                            | $T_{vj} = 25^{\circ}\text{C}$                                                                                                                                                                                                                                                                                     | $R_{Gint}$          |      | 2,5          |              | $\Omega$                       |
| Eingangskapazität<br>input capacitance                                       | $f = 1\text{ MHz}$ , $T_{vj} = 25^{\circ}\text{C}$ , $V_{CE} = 25\text{ V}$ , $V_{GE} = 0\text{ V}$                                                                                                                                                                                                               | $C_{ies}$           |      | 25,0         |              | nF                             |
| Rückwirkungskapazität<br>reverse transfer capacitance                        | $f = 1\text{ MHz}$ , $T_{vj} = 25^{\circ}\text{C}$ , $V_{CE} = 25\text{ V}$ , $V_{GE} = 0\text{ V}$                                                                                                                                                                                                               | $C_{res}$           |      | 1,40         |              | nF                             |
| Kollektor-Emitter Reststrom<br>collector-emitter cut-off current             | $V_{CE} = 3300\text{ V}$ , $V_{GE} = 0\text{ V}$ , $T_{vj} = 25^{\circ}\text{C}$                                                                                                                                                                                                                                  | $I_{CES}$           |      |              | 5,0          | mA                             |
| Gate-Emitter Reststrom<br>gate-emitter leakage current                       | $V_{CE} = 0\text{ V}$ , $V_{GE} = 20\text{ V}$ , $T_{vj} = 25^{\circ}\text{C}$                                                                                                                                                                                                                                    | $I_{GES}$           |      |              | 400          | nA                             |
| Einschaltverzögerungszeit (ind. Last)<br>turn-on delay time (inductive load) | $I_C = 200\text{ A}$ , $V_{CE} = 1800\text{ V}$<br>$V_{GE} = \pm 15\text{ V}$ , $R_{Gon} = 5,6\ \Omega$ , $C_{GE} = 33,0\text{ nF}$ , $T_{vj} = 25^{\circ}\text{C}$<br>$V_{GE} = \pm 15\text{ V}$ , $R_{Gon} = 5,6\ \Omega$ , $C_{GE} = 33,0\text{ nF}$ , $T_{vj} = 125^{\circ}\text{C}$                          | $t_{d\text{ on}}$   |      | 0,28<br>0,28 |              | $\mu\text{s}$<br>$\mu\text{s}$ |
| Anstiegszeit (induktive Last)<br>rise time (inductive load)                  | $I_C = 200\text{ A}$ , $V_{CE} = 1800\text{ V}$<br>$V_{GE} = \pm 15\text{ V}$ , $R_{Gon} = 5,6\ \Omega$ , $C_{GE} = 33,0\text{ nF}$ , $T_{vj} = 25^{\circ}\text{C}$<br>$V_{GE} = \pm 15\text{ V}$ , $R_{Gon} = 5,6\ \Omega$ , $C_{GE} = 33,0\text{ nF}$ , $T_{vj} = 125^{\circ}\text{C}$                          | $t_r$               |      | 0,18<br>0,20 |              | $\mu\text{s}$<br>$\mu\text{s}$ |
| Abschaltverzögerungszeit (ind. Last)<br>turn-off delay time (inductive load) | $I_C = 200\text{ A}$ , $V_{CE} = 1800\text{ V}$<br>$V_{GE} = \pm 15\text{ V}$ , $R_{Goff} = 7,5\ \Omega$ , $C_{GE} = 33,0\text{ nF}$ , $T_{vj} = 25^{\circ}\text{C}$<br>$V_{GE} = \pm 15\text{ V}$ , $R_{Goff} = 7,5\ \Omega$ , $C_{GE} = 33,0\text{ nF}$ , $T_{vj} = 125^{\circ}\text{C}$                        | $t_{d\text{ off}}$  |      | 1,55<br>1,70 |              | $\mu\text{s}$<br>$\mu\text{s}$ |
| Fallzeit (induktive Last)<br>fall time (inductive load)                      | $I_C = 200\text{ A}$ , $V_{CE} = 1800\text{ V}$<br>$V_{GE} = \pm 15\text{ V}$ , $R_{Goff} = 7,5\ \Omega$ , $C_{GE} = 33,0\text{ nF}$ , $T_{vj} = 25^{\circ}\text{C}$<br>$V_{GE} = \pm 15\text{ V}$ , $R_{Goff} = 7,5\ \Omega$ , $C_{GE} = 33,0\text{ nF}$ , $T_{vj} = 125^{\circ}\text{C}$                        | $t_f$               |      | 0,20<br>0,20 |              | $\mu\text{s}$<br>$\mu\text{s}$ |
| Einschaltverlustenergie pro Puls<br>turn-on energy loss per pulse            | $I_C = 200\text{ A}$ , $V_{CE} = 1800\text{ V}$ , $L_s = 70\text{ nH}$<br>$V_{GE} = \pm 15\text{ V}$ , $R_{Gon} = 5,6\ \Omega$ , $C_{GE} = 33,0\text{ nF}$ , $T_{vj} = 25^{\circ}\text{C}$<br>$V_{GE} = \pm 15\text{ V}$ , $R_{Gon} = 5,6\ \Omega$ , $C_{GE} = 33,0\text{ nF}$ , $T_{vj} = 125^{\circ}\text{C}$   | $E_{on}$            |      | 235<br>365   |              | mJ<br>mJ                       |
| Abschaltverlustenergie pro Puls<br>turn-off energy loss per pulse            | $I_C = 200\text{ A}$ , $V_{CE} = 1800\text{ V}$ , $L_s = 70\text{ nH}$<br>$V_{GE} = \pm 15\text{ V}$ , $R_{Goff} = 7,5\ \Omega$ , $C_{GE} = 33,0\text{ nF}$ , $T_{vj} = 25^{\circ}\text{C}$<br>$V_{GE} = \pm 15\text{ V}$ , $R_{Goff} = 7,5\ \Omega$ , $C_{GE} = 33,0\text{ nF}$ , $T_{vj} = 125^{\circ}\text{C}$ | $E_{off}$           |      | 215<br>255   |              | mJ<br>mJ                       |
| Kurzschlußverhalten<br>SC data                                               | $t_P \leq 10\ \mu\text{s}$ , $V_{GE} \leq 15\text{ V}$<br>$T_{vj} \leq 125^{\circ}\text{C}$ , $V_{CC} = 2500\text{ V}$ , $V_{CEmax} = V_{CES} - L_{sCE} \cdot di/dt$                                                                                                                                              | $I_{SC}$            |      | 1000         |              | A                              |
| Innerer Wärmewiderstand<br>thermal resistance, junction to case              | pro IGBT<br>per IGBT                                                                                                                                                                                                                                                                                              | $R_{thJC}$          |      |              | 57,0         | K/kW                           |
| Übergangs-Wärmewiderstand<br>thermal resistance, case to heatsink            | pro IGBT / per IGBT<br>$\lambda_{Paste} = 1\text{ W/(m}\cdot\text{K)}$ / $\lambda_{grease} = 1\text{ W/(m}\cdot\text{K)}$                                                                                                                                                                                         | $R_{thCH}$          |      | 49,0         |              | K/kW                           |

Vorläufige Daten  
preliminary data

## Diode-Wechselrichter / diode-inverter

## Höchstzulässige Werte / maximum rated values

|                                                                     |                                                                              |                |              |                       |
|---------------------------------------------------------------------|------------------------------------------------------------------------------|----------------|--------------|-----------------------|
| Periodische Spitzensperrspannung<br>repetitive peak reverse voltage | $T_{vj} = 25^{\circ}\text{C}$<br>$T_{vj} = -25^{\circ}\text{C}$              | $V_{RRM}$      | 3300<br>3300 | V                     |
| Dauergleichstrom<br>DC forward current                              |                                                                              | $I_F$          | 200          | A                     |
| Periodischer Spitzenstrom<br>repetitive peak forward current        | $t_P = 1 \text{ ms}$                                                         | $I_{FRM}$      | 400          | A                     |
| Grenzlastintegral<br>$I^2t$ - value                                 | $V_R = 0 \text{ V}$ , $t_P = 10 \text{ ms}$ , $T_{vj} = 125^{\circ}\text{C}$ | $I^2t$         | 14,0         | $\text{kA}^2\text{s}$ |
| Spitzenverlustleistung<br>maximum power dissipation                 | $T_{vj} = 125^{\circ}\text{C}$                                               | $P_{RQM}$      | 400          | kW                    |
| Mindesteinschaltzeit<br>minimum turn-on time                        |                                                                              | $t_{Fon \min}$ | 10,0         | $\mu\text{s}$         |

## Charakteristische Werte / characteristic values

|                                                                   |                                                                                                                                                                                                                                            |            | min. | typ.         | max.         |                                |
|-------------------------------------------------------------------|--------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------|------------|------|--------------|--------------|--------------------------------|
| Durchlassspannung<br>forward voltage                              | $I_F = 200 \text{ A}$ , $V_{GE} = 0 \text{ V}$ , $T_{vj} = 25^{\circ}\text{C}$<br>$I_F = 200 \text{ A}$ , $V_{GE} = 0 \text{ V}$ , $T_{vj} = 125^{\circ}\text{C}$                                                                          | $V_F$      |      | 2,80<br>2,80 | 3,50<br>3,50 | V<br>V                         |
| Rückstromspitze<br>peak reverse recovery current                  | $I_F = 200 \text{ A}$ , $-di_F/dt = 1100 \text{ A}/\mu\text{s}$<br>$V_R = 1800 \text{ V}$ , $V_{GE} = -15 \text{ V}$ , $T_{vj} = 25^{\circ}\text{C}$<br>$V_R = 1800 \text{ V}$ , $V_{GE} = -15 \text{ V}$ , $T_{vj} = 125^{\circ}\text{C}$ | $I_{RM}$   |      | 275<br>325   |              | A<br>A                         |
| Sperrverzögerungsladung<br>recovered charge                       | $I_F = 200 \text{ A}$ , $-di_F/dt = 1100 \text{ A}/\mu\text{s}$<br>$V_R = 1800 \text{ V}$ , $V_{GE} = -15 \text{ V}$ , $T_{vj} = 25^{\circ}\text{C}$<br>$V_R = 1800 \text{ V}$ , $V_{GE} = -15 \text{ V}$ , $T_{vj} = 125^{\circ}\text{C}$ | $Q_r$      |      | 120<br>220   |              | $\mu\text{C}$<br>$\mu\text{C}$ |
| Abschaltenergie pro Puls<br>reverse recovery energy               | $I_F = 200 \text{ A}$ , $-di_F/dt = 1100 \text{ A}/\mu\text{s}$<br>$V_R = 1800 \text{ V}$ , $V_{GE} = -15 \text{ V}$ , $T_{vj} = 25^{\circ}\text{C}$<br>$V_R = 1800 \text{ V}$ , $V_{GE} = -15 \text{ V}$ , $T_{vj} = 125^{\circ}\text{C}$ | $E_{rec}$  |      | 125<br>255   |              | mJ<br>mJ                       |
| Innerer Wärmewiderstand<br>thermal resistance, junction to case   | pro Diode<br>per diode                                                                                                                                                                                                                     | $R_{thJC}$ |      |              | 110          | K/kW                           |
| Übergangs-Wärmewiderstand<br>thermal resistance, case to heatsink | pro Diode / per diode<br>$\lambda_{Paste} = 1 \text{ W}/(\text{m}\cdot\text{K})$ / $\lambda_{grease} = 1 \text{ W}/(\text{m}\cdot\text{K})$                                                                                                | $R_{thCH}$ |      | 93,0         |              | K/kW                           |

**Vorläufige Daten**  
**preliminary data****Modul / module**

|                                                                                              |                                                                                            |                      |              |           |
|----------------------------------------------------------------------------------------------|--------------------------------------------------------------------------------------------|----------------------|--------------|-----------|
| Isolations-Prüfspannung<br>insulation test voltage                                           | RMS, f = 50 Hz, t = 1 min.                                                                 | V <sub>ISOL</sub>    | 6,0          | kV        |
| Teilentladungs Aussetzspannung<br>partial discharge extinction voltage                       | RMS, f = 50 Hz, Q <sub>PD</sub> ≤ 10 pC (acc. to IEC 1287)                                 | V <sub>ISOL</sub>    | 2,6          | kV        |
| Kollektor-Emitter-Gleichsperrspannung<br>DC stability                                        | T <sub>vj</sub> = 25°C, 100 fit                                                            | V <sub>CE D</sub>    | 1800         | V         |
| Material Modulgrundplatte<br>material of module baseplate                                    |                                                                                            |                      | AlSiC        |           |
| Material für innere Isolation<br>material for internal insulation                            |                                                                                            |                      | AlN          |           |
| Kriechstrecke<br>creepage distance                                                           | Kontakt - Kühlkörper / terminal to heatsink<br>Kontakt - Kontakt / terminal to terminal    |                      | 32,0<br>32,0 | mm        |
| Luftstrecke<br>clearance distance                                                            | Kontakt - Kühlkörper / terminal to heatsink<br>Kontakt - Kontakt / terminal to terminal    |                      | 19,0<br>19,0 | mm        |
| Vergleichszahl der Kriechwegbildung<br>comparative tracking index                            |                                                                                            | CTI                  | > 400        |           |
| min. typ. max.                                                                               |                                                                                            |                      |              |           |
| Übergangs-Wärmewiderstand<br>thermal resistance, case to heatsink                            | pro Modul / per module<br>λ <sub>Paste</sub> = 1 W/(m·K) / λ <sub>grease</sub> = 1 W/(m·K) | R <sub>thCH</sub>    | 16,0         | K/kW      |
| Modulinduktivität<br>stray inductance module                                                 |                                                                                            | L <sub>sCE</sub>     | 58           | nH        |
| Modulleitungswiderstand,<br>Anschlüsse - Chip<br>module lead resistance,<br>terminals - chip | T <sub>C</sub> = 25°C, pro Zweig / per arm                                                 | R <sub>CC'+EE'</sub> | 0,78         | mΩ        |
| Höchstzulässige Sperrschichttemperatur<br>maximum junction temperature                       |                                                                                            | T <sub>vj max</sub>  | 150          | °C        |
| Temperatur im Schaltbetrieb<br>temperature under switching conditions                        |                                                                                            | T <sub>vj op</sub>   | -40          | 125 °C    |
| Lagertemperatur<br>storage temperature                                                       |                                                                                            | T <sub>stg</sub>     | -40          | 125 °C    |
| Anzugsdrehmoment f. mech. Befestigung<br>mounting torque                                     | Schraube / screw M6                                                                        | M                    | 4,25         | - 5,75 Nm |
| Anzugsdrehmoment f. elektr. Anschlüsse<br>terminal connection torque                         | Schraube / screw M5                                                                        | M                    | 3,6          | - 4,2 Nm  |
| Gewicht<br>weight                                                                            |                                                                                            | G                    | 500          | g         |

**Mit dieser technischen Information werden Halbleiterbauelemente spezifiziert, jedoch keine Eigenschaften zugesichert. Sie gilt in Verbindung mit den zugehörigen technischen Erläuterungen.**

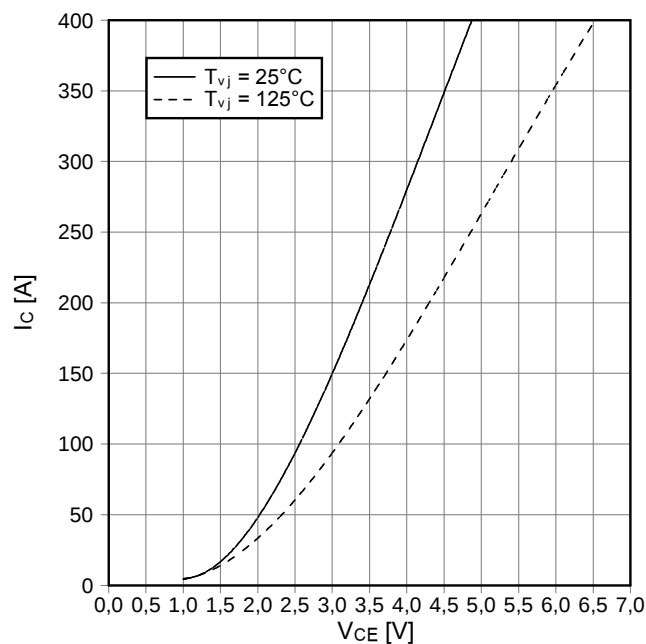
**This technical information specifies semiconductor devices but guarantees no characteristics. It is valid with the appropriate technical explanations.**

|                              |                                |
|------------------------------|--------------------------------|
| prepared by: Jürgen Biermann | date of publication: 2003-6-12 |
| approved by: Christoph Lübke | revision: 2.0                  |

## Vorläufige Daten preliminary data

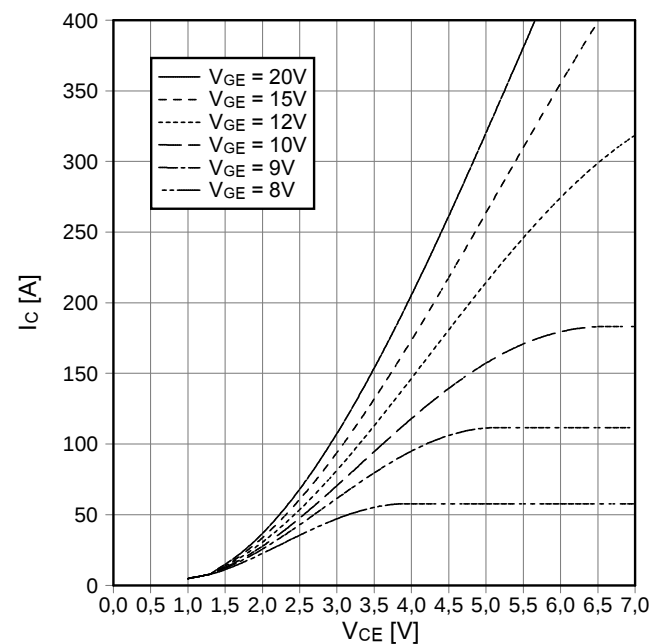
Ausgangskennlinie IGBT-Wechselr. (typisch)  
output characteristic IGBT-inverter (typical)

$I_C = f(V_{CE})$   
 $V_{GE} = 15 \text{ V}$



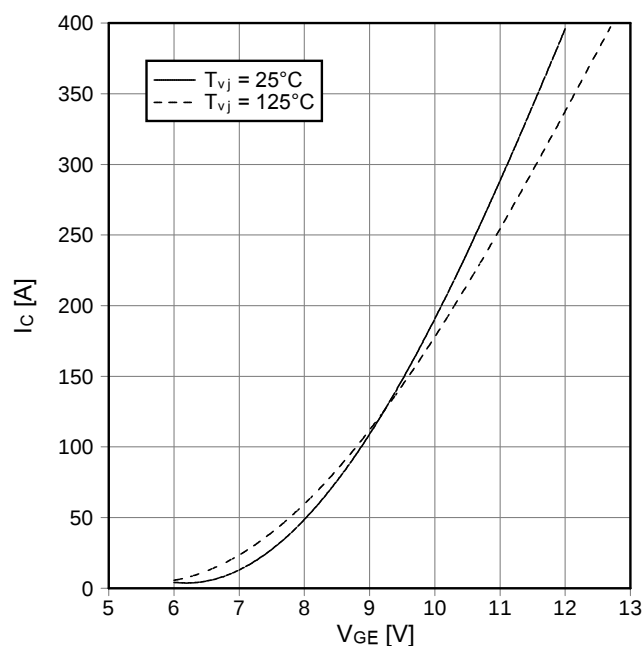
Ausgangskennlinienfeld IGBT-Wechselr. (typisch)  
output characteristic IGBT-inverter (typical)

$I_C = f(V_{CE})$   
 $T_{vj} = 125^\circ\text{C}$



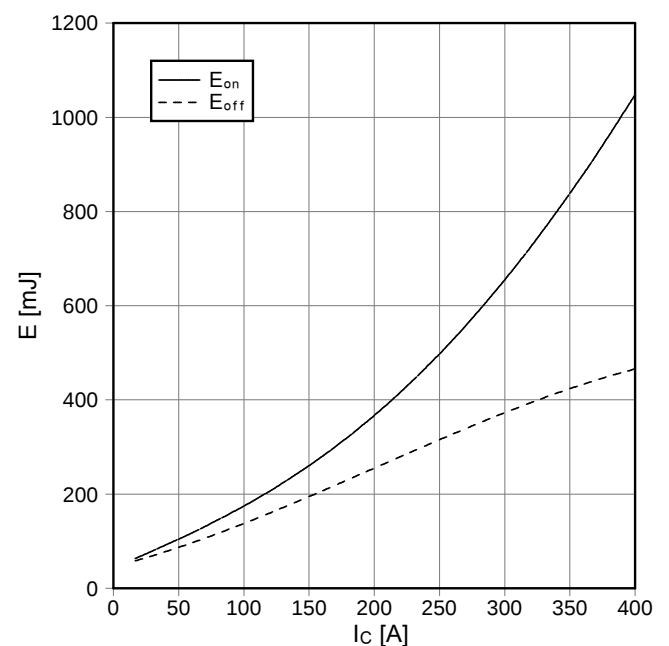
Übertragungscharakteristik IGBT-Wechselr. (typisch)  
transfer characteristic IGBT-inverter (typical)

$I_C = f(V_{GE})$   
 $V_{CE} = 20 \text{ V}$



Schaltverluste IGBT-Wechselr. (typisch)  
switching losses IGBT-inverter (typical)

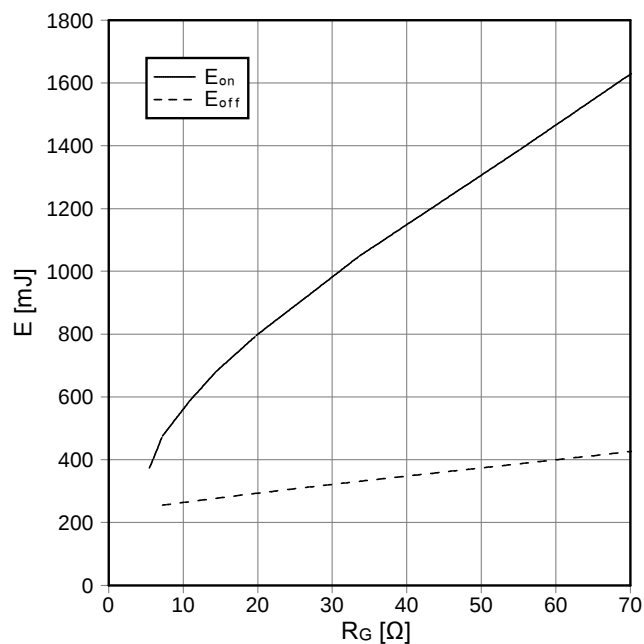
$E_{on} = f(I_C)$ ,  $E_{off} = f(I_C)$   
 $V_{GE} = \pm 15 \text{ V}$ ,  $R_{Gon} = 5,6 \Omega$ ,  $R_{Goff} = 7,5 \Omega$ ,  $V_{CE} = 1800 \text{ V}$ ,  
 $T_{vj} = 125^\circ\text{C}$ ,  $C_{GE} = 33 \text{ nF}$



# Vorläufige Daten preliminary data

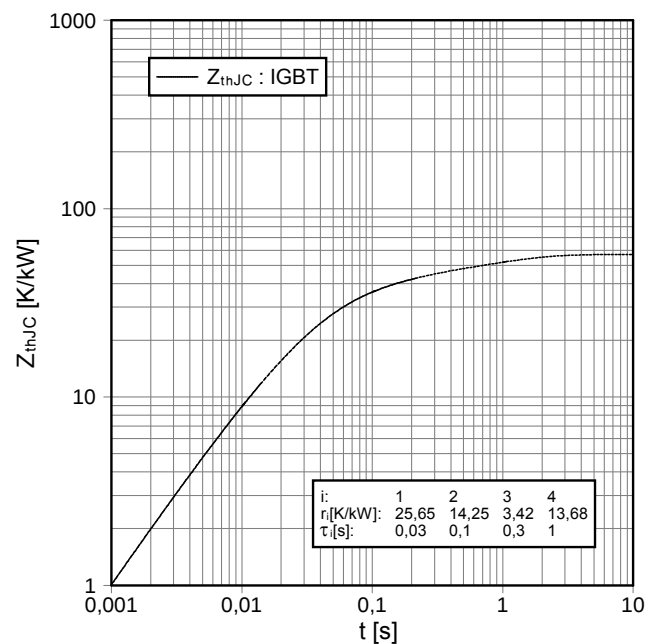
Schaltverluste IGBT-Wechselr. (typisch)  
switching losses IGBT-Inverter (typical)

$E_{on} = f(R_G)$ ,  $E_{off} = f(R_G)$   
 $V_{GE} = \pm 15 \text{ V}$ ,  $I_C = 200 \text{ A}$ ,  $V_{CE} = 1800 \text{ V}$ ,  $T_{vj} = 125^\circ\text{C}$ ,  
 $C_{GE} = 33 \text{ nF}$



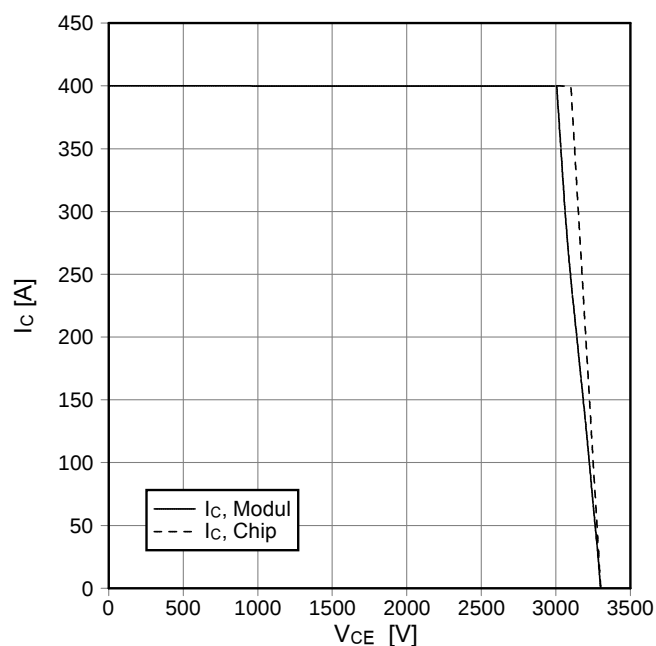
Transienter Wärmewiderstand IGBT-Wechselr.  
transient thermal impedance IGBT-inverter

$Z_{thJC} = f(t)$



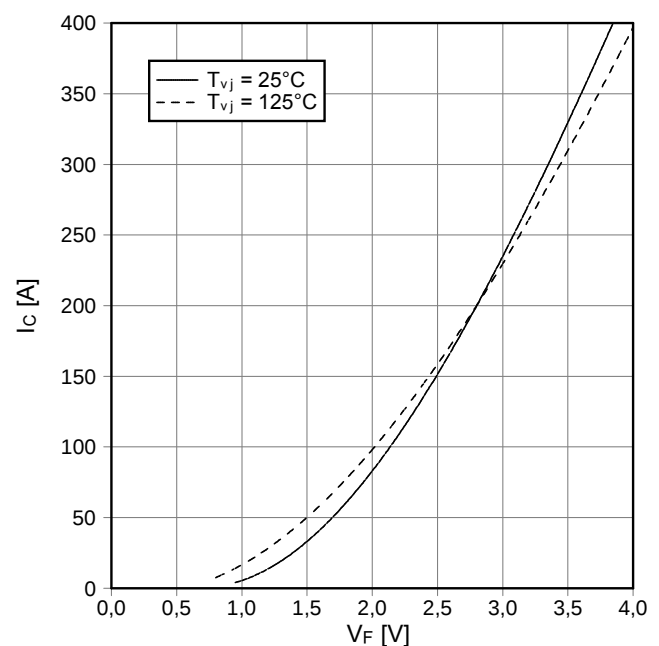
Sicherer Rückwärts-Arbeitsbereich IGBT-Wr. (RBSOA)  
reverse bias safe operating area IGBT-inv. (RBSOA)

$I_C = f(V_{CE})$   
 $V_{GE} = \pm 15 \text{ V}$ ,  $R_{Goff} = 7,5 \Omega$ ,  $T_{vj} = 125^\circ\text{C}$ ,  $C_{GE} = 33 \text{ nF}$



Durchlaßkennlinie der Diode-Wechselr. (typisch)  
forward characteristic of diode-inverter (typical)

$I_F = f(V_F)$

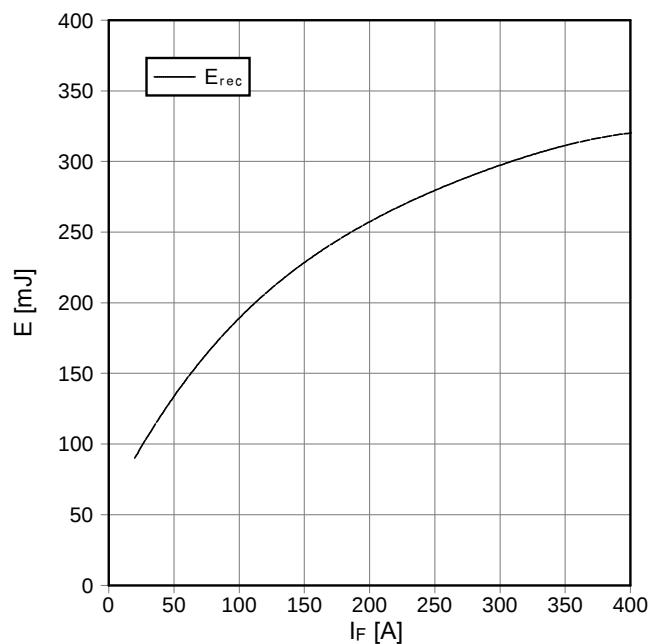


**Vorläufige Daten  
preliminary data**

**Schaltverluste Diode-Wechselr. (typisch)  
switching losses diode-inverter (typical)**

$$E_{rec} = f(I_F)$$

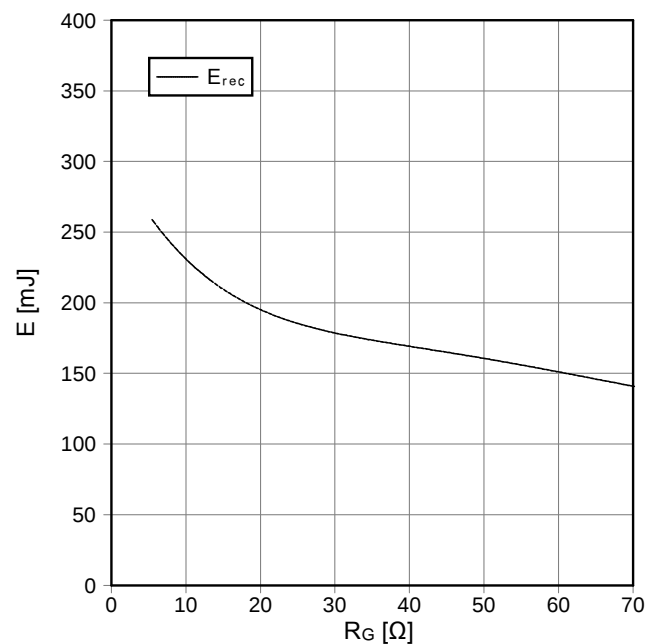
$R_{Gon} = 5,6 \Omega$ ,  $V_{CE} = 1800 \text{ V}$ ,  $T_{vj} = 125^\circ\text{C}$



**Schaltverluste Diode-Wechselr. (typisch)  
switching losses diode-inverter (typical)**

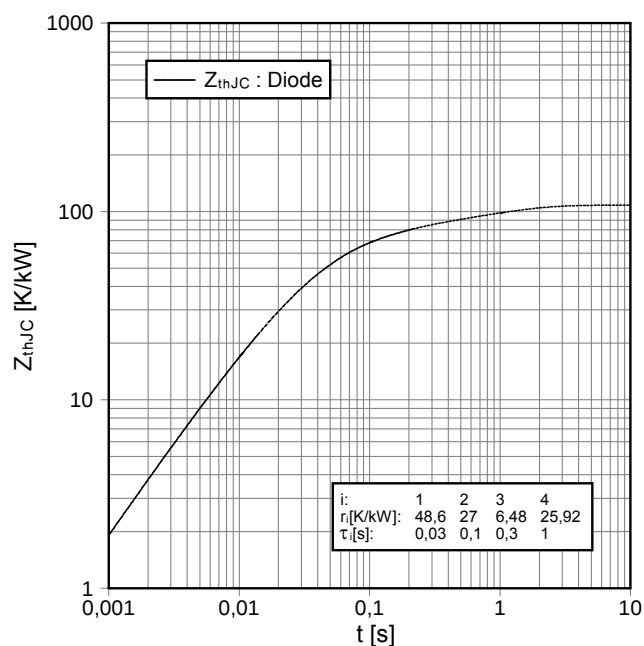
$$E_{rec} = f(R_G)$$

$I_F = 200 \text{ A}$ ,  $V_{CE} = 1800 \text{ V}$ ,  $T_{vj} = 125^\circ\text{C}$



**Transienter Wärmewiderstand Diode-Wechselr.  
transient thermal impedance diode-inverter**

$$Z_{thJC} = f(t)$$

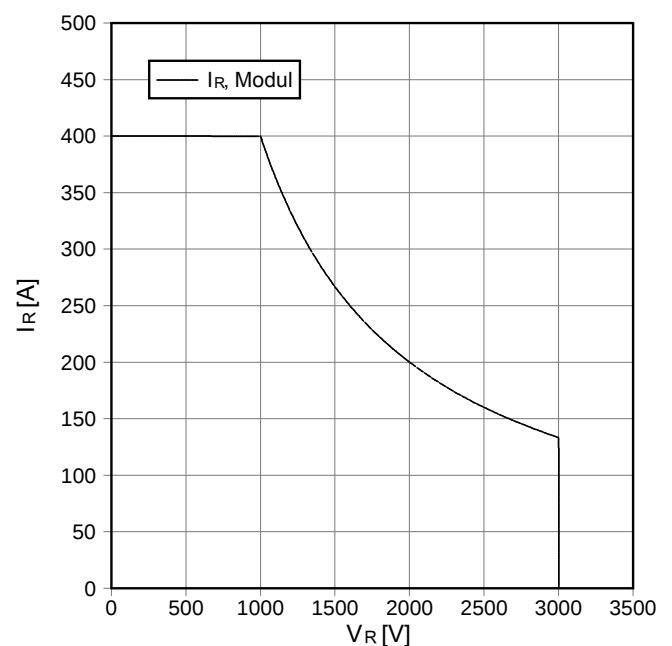


|                        |      |     |      |       |
|------------------------|------|-----|------|-------|
| i:                     | 1    | 2   | 3    | 4     |
| r <sub>i</sub> [K/kW]: | 48,6 | 27  | 6,48 | 25,92 |
| τ <sub>i</sub> [s]:    | 0,03 | 0,1 | 0,3  | 1     |

**Sicherer Arbeitsbereich Diode-Wechselr. (SOA)  
safe operation area diode-inverter (SOA)**

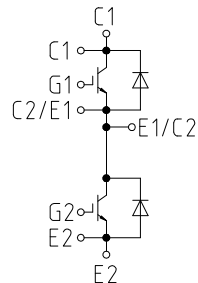
$$I_R = f(V_R)$$

$T_{vj} = 125^\circ\text{C}$

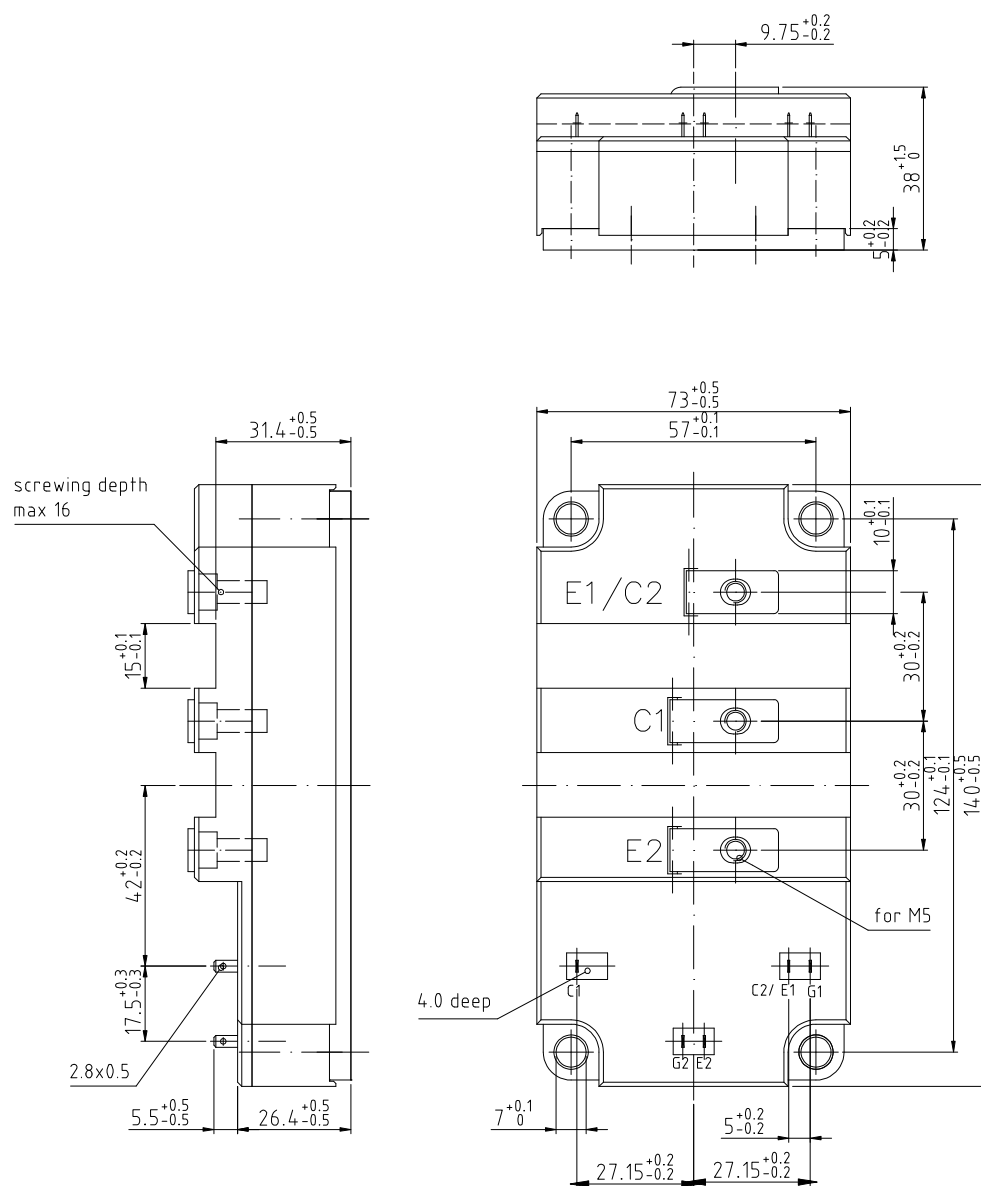


**Vorläufige Daten**  
**preliminary data**

**Schaltplan / circuit diagram**



**Gehäuseabmessungen / package outlines**



prepared by: Jürgen Biemann

date of publication: 2003-6-12

approved by: Christoph Lübke

revision: 2.0

## **Terms & Conditions of Usage**

### **Attention**

The present product data is exclusively subscribed to technically experienced staff. This Data Sheet is describing the specification of the products for which a warranty is granted exclusively pursuant the terms and conditions of the supply agreement. There will be no guarantee of any kind for the product and its specifications. Changes to the Data Sheet are reserved.

You and your technical departments will have to evaluate the suitability of the product for the intended application and the completeness of the product data with respect to such application. Should you require product information in excess of the data given in the Data Sheet, please contact your local Sales Office via "[www.eupec.com](http://www.eupec.com) / sales & contact".

### **Warning**

Due to technical requirements the products may contain dangerous substances. For information on the types in question please contact your local Sales Office via "[www.eupec.com](http://www.eupec.com) / sales & contact".

Компания «Life Electronics» занимается поставками электронных компонентов импортного и отечественного производства от производителей и со складов крупных дистрибьюторов Европы, Америки и Азии.

С конца 2013 года компания активно расширяет линейку поставок компонентов по направлению коаксиальный кабель, кварцевые генераторы и конденсаторы (керамические, пленочные, электролитические), за счёт заключения дистрибьюторских договоров

Мы предлагаем:

- Конкурентоспособные цены и скидки постоянным клиентам.
- Специальные условия для постоянных клиентов.
- Подбор аналогов.
- Поставку компонентов в любых объемах, удовлетворяющих вашим потребностям.
- Приемлемые сроки поставки, возможна ускоренная поставка.
- Доставку товара в любую точку России и стран СНГ.
- Комплексную поставку.
- Работу по проектам и поставку образцов.
- Формирование склада под заказчика.
- Сертификаты соответствия на поставляемую продукцию (по желанию клиента).
- Тестирование поставляемой продукции.
- Поставку компонентов, требующих военную и космическую приемку.
- Входной контроль качества.
- Наличие сертификата ISO.

В составе нашей компании организован Конструкторский отдел, призванный помогать разработчикам, и инженерам.

Конструкторский отдел помогает осуществить:

- Регистрацию проекта у производителя компонентов.
- Техническую поддержку проекта.
- Защиту от снятия компонента с производства.
- Оценку стоимости проекта по компонентам.
- Изготовление тестовой платы монтаж и пусконаладочные работы.



Тел: +7 (812) 336 43 04 (многоканальный)

Email: [org@lifeelectronics.ru](mailto:org@lifeelectronics.ru)

[www.lifeelectronics.ru](http://www.lifeelectronics.ru)